

| Title                       | Reference Design Report for a 30 W Supply<br>Using TOPSwitch <sup>®</sup> -JX TOP266VG |  |  |
|-----------------------------|--|--|--|
| Specification               | 85 VAC – 264 VAC Input; 12 V, 2.5 A Output   |  |  |
| Application General Purpose |  |  |  |
| Author                      | Applications Engineering Department  |  |  |
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#### Summary and Features

- Highly energy efficient
  - Very low no-load input power: < 80 mW at 230 VAC
  - Full load efficiency >84% at 115 VAC / 47 Hz
  - Efficiency >80% above 8% load
  - Average efficiency >84% (25%, 50%, 75%, 100% load points)
  - Simplifies meeting ENERGY STAR 2.0, 80 Plus and EuP requirements
  - 725 V MOSFET rating allowed high turns ratio (V<sub>OR</sub>) and use of 60 V Schottky output diode
- Low cost, low component count and small PCB footprint solution
  - 132 kHz operation optimizes core size and efficiency performance
  - Low-profile eDIP<sup>™</sup> package with no external heatsink
- Integrated Protection and Reliability Features
  - Line undervoltage lock out (UVLO) and line overvoltage shutdown prevents output glitching and improves reliability
  - Primary sensed output overvoltage shutdown (OVP) eliminates second optocoupler
  - Auto recovery output over current (OCP) and short circuit protection
  - Flat overload power with line voltage
  - Meets limited power source (LPS) <100 VA requirement with a single point of failure
  - Accurate thermal shutdown with large hysteresis

PATENT INFORMATION

The products and applications illustrated herein (including transformer construction and circuits external to the products) may be covered by one or more U.S. and foreign patents, or potentially by pending U.S. and foreign patent applications assigned to Power Integrations. A complete list of Power Integrations' patents may be found at www.powerint.com. Power Integrations grants its customers a license under certain patent rights as set forth at <htp://www.powerint.com/ip.htm>.

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### **Important Note:**

Although this board is designed to satisfy safety isolation requirements, the engineering prototype has not been agency approved. Therefore, all testing should be performed using an isolation transformer to provide the AC input to the prototype board.



# 1 Introduction

This engineering report describes a power supply employing the Power Integrations<sup>®</sup> TOPSwitch<sup>®</sup>-JX TOP266VG. This power supply operates over a universal input range and provides a 12 V, 30 W output. It has been designed and tested to operate open frame with an ambient temperature environment of up to 40 °C.

The TOPSwitch-JX, by design, maintains virtually constant efficiency across a very wide load range without using special operating modes to meet specific load thresholds. This optimizes performance for existing and emerging energy-efficiency regulations. Maintaining constant efficiency ensures design optimization for future energy-efficiency regulation changes without the need for redesign.

The low MOSFET capacitance of TOPSwitch-JX allows a higher switching frequency without the efficiency penalty which occurs with standard discrete MOSFET. The 132 kHz switching frequency (rather than the 70 kHz to 100 kHz frequency used for a discrete MOSFET) reduces the transformer size required, and so reduces cost.

This power supply offers the following protection features:

- Output OVP (including open loop) with latching shutdown
- Auto-recovery type overload protection

This document provides complete design details including specifications, the schematic, bill of materials, and transformer design and construction information. This information includes performance results pertaining to regulation, efficiency, standby, transient load, power-limit data, and conducted EMI scans.





Figure 1 – Populated Circuit Board Photograph, Component Side.

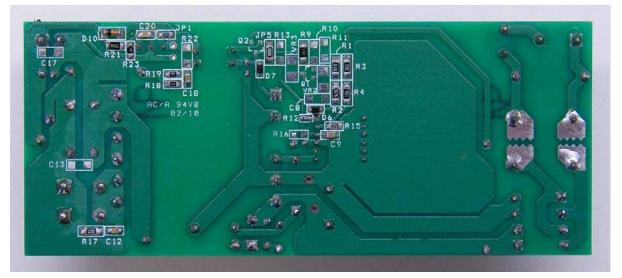


Figure 2 – Populated Circuit Board Photograph, Solder Side.



### 01-Mar-10

# 2 Power Supply Specification

The table below represents the minimum acceptable performance of the design. Actual performance is listed in the results section.

| Description   | Symbol  | Min  | Тур   | Мах                | Units          | Comment  |
|---|---|--|-------|--------------------|----------------|--|
| <b>Input</b><br>Voltage<br>Frequency<br>No-load Input Power (230 VAC)                     | V <sub>IN</sub><br>f <sub>LINE</sub>                        | 85<br>47                                     | 50/60 | 264<br>63<br>0.08  | VAC<br>Hz<br>W | 2 Wire – no P.E.   |
| Output<br>Output Voltage<br>Output Ripple Voltage<br>Output Current<br>Total Output Power | V <sub>out</sub><br>V <sub>ripple</sub><br>I <sub>out</sub> | 11.4<br>0                                    | 12    | 12.6<br>120<br>2.5 | V<br>mV<br>A   | 20 MHz bandwidth   |
| Continuous Output Power<br>LPS  | P <sub>OUT</sub><br>P <sub>OUT_PEAK</sub>                   |  | 30    | 100                | W<br>W         | To meet LPS safety requirement   |
| Efficiency  |   |  |       |                    |                |  |
| Full Load   | η   | 80   |       |                    | %              | Measured at P <sub>OUT</sub> 25 °C,<br>90 VAC / 60Hz   |
| Required average efficiency at 25, 50, 75 and 100 % of P <sub>OUT</sub>                   | $\eta_{\text{ES2.0}}$                                       | 83   |       |                    | %              | Per ENERGY STAR V2.0   |
| Environmental   |   |  |       |                    |                |  |
| Conducted EMI   |   | Meets CISPR22B / EN55022B                    |       |                    |                |  |
| Safety  |   | Designed to meet IEC950 / UL1950<br>Class II |       |                    |                |  |
| Line Surge<br>Differential Mode (L1-L2)<br>Common Mode (L1/L2-PE)                         |   |  |       | 1<br>2             | kV<br>kV       | 1.2/50 μs surge, IEC 1000-4-5,<br>Series Impedance:<br>Differential Mode: 2 Ω<br>Common Mode: 12 Ω |
| Ambient Temperature   | Т <sub>АМВ</sub>  | 0  |       | 40                 | °C             | Free convection, sea level   |



# 3 Schematic

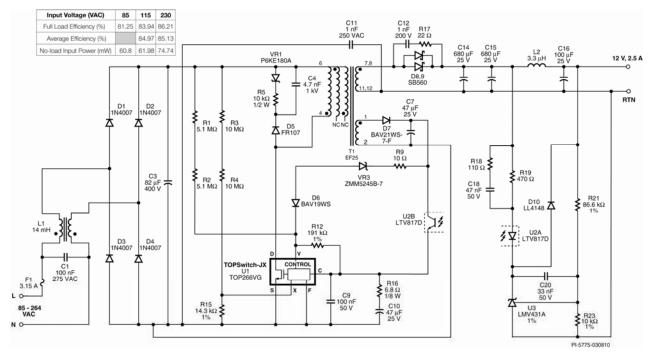


Figure 3 – Schematic.



# 4 Circuit Description

This power supply employs a TOP266VG off-line switcher, (U1), in a flyback configuration. IC U1 has an integrated 725 V MOSFET and a multi-mode controller. It regulates the output by adjusting the MOSFET duty cycle, based on the current fed into its CONTROL (C) pin.

### 4.1 Key Design Decisions

The goals of the design were highest full load efficiency, average efficiency (average of 25%, 50%, 75% and 100% load points) and very low no-load consumption.

Additional requirements included latching output overvoltage shutdown and compliance to safety agency limited power source (LPS) limits. Actual efficiency and no-load performance easily exceeded current energy efficiency requirements.

In order to meet these design goals the following key design decisions were made.

### 4.1.1 PI part selection

• Ambient of 40 °C allowed one device size smaller than indicated by the power table.

The device selected for this design was based on the 85-265 VAC, Open Frame, PCB heatsinking column of the datasheet power table (Table 1). One device size smaller was selected (TOP266V vs TOP267V) due to the ambient specification of 40 °C (vs. the 50°C assumed in the power table) and the optimum PCB area and layout for the device heatsink. The subsequent thermal and efficiency data confirmed this choice. The maximum device temperature was 107 °C at full load, 40 °C, 85 VAC, 47 Hz (worst case conditions) and average efficiency exceeded 83% ENERGY STAR and EuP Tier 2 requirements.

#### 4.1.2 Transformer Core Selection

• 132 kHz switching frequency allowed the selection of smaller core for lower cost.

The size of the magnetic core is a function of the switching frequency. The choice of the higher switching frequency of 132 kHz allowed for the use of a smaller core size. The higher switching frequency does not negatively impact the efficiency in TOPSwitch-JX designs due its small drain to source capacitance ( $C_{OSS}$ ) as compared to that of discrete MOSFETs.

#### 4.1.3 Line Sense Resistor Values

- Increasing line sensing resistance from 4 M $\Omega$  to 10.2 M $\Omega$  to reduce no-load input power dissipation by 16 mW

Line sensing is provided by resistors R1 and R2 and sets the line undervoltage and overvoltage thresholds. The combined value of these resistors was increased from the standard 4 M $\Omega$  to 10.2 M $\Omega$ . This reduced the resistor, and therefore contribution to no-



load input power, from ~26 mW to ~10 mW. To compensate the resultant change in the UV threshold resistor R12 was added between the CONTROL and VOLTAGE-MONITOR pins. This adds a DC current equal to ~16 mA into the V pin, requiring only 9  $\mu$ A to be provided via R1 and R2 to reach the V pin UV threshold current of 25  $\mu$ A and setting the UV threshold to approximately 95 VDC.

This technique does effectively disable the line OV feature as the resultant OV threshold is raised from ~450 VDC to ~980 VDC. However in this design there was no impact as the value of input capacitance (C3) was sufficient to allow the design to withstand differential line surges greater than 1 kV without the peak drain voltage reaching the  $BV_{DSS}$  rating of U1.

Specific guidelines and detailed calculations for the value of R12 may be found in the TOPSwitch-JX Application Note AN-47.

### 4.1.4 Clamp Configuration – RZCD vs RCD

• An RZCD (Zener bleed) was selected over RCD to give higher light load efficiency and lower no-load consumption

The clamp network is formed by VR1, C4, R5 and D5. It limits the peak drain voltage spike caused by leakage inductance to below the BV<sub>DSS</sub> rating of the internal TOPSwitch-JX MOSFET. This arrangement was selected over a standard RCD clamp to improve light load efficiency and no-load input power.

In a standard RCD clamp C4 would be discharged by a parallel resistor rather than a resistor and series Zener. In an RCD clamp the resistor value of R5 is selected to limit the peak drain voltage under full load and over-load conditions. However under light or no-load conditions this resistor value now causes the capacitor voltage to discharge significantly as both the leakage inductance energy and switching frequency are lower. As the capacitor has to be recharged to above the reflected output voltage each switching cycle the lower capacitor voltage represents wasted energy. It has the effect of making the clamp dissipation appear as a significant load just as if it were connected to the output of the power supply.

The RZCD arrangement solves this problem by preventing the voltage across the capacitor discharging below a minimum value (defined by the voltage rating of VR1) and therefore minimizing clamp dissipation under light and no-load conditions. Zener VR1 is shown as a high peak dissipation capable TVS however a standard lower cost Zener may also be used due to the low peak current that component experiences.

In many designs a resistor value of less than 50  $\Omega$  may be used in series with C4 to damp out high frequency ringing and improve EMI but this was not necessary in this case.



### 4.1.5 Feedback Configuration

- A high CTR optocoupler was used to reduce secondary bias currents and no-load input power
- Low voltage, low current voltage reference IC used on secondary side to reduce secondary side feedback current and no-load input power.
- Bias winding voltage tuned to ~9 V at no-load, high line to reduce no-load input power

Typically the feedback current into the CONTROL pin at high line is  $\sim$ 3 mA. This current is both sourced from the bias winding (voltage across C10) and directly from the output. Both of these represent a load on the output of the power supply.

To minimize the dissipation from the bias winding under no-load conditions the number of bias winding turns and value of C7 was adjusted to give a minimum voltage across C7 of  $\sim$ 9 V. This was the minimum achievable to keep the optocoupler biased and the output in regulation.

To minimize the dissipation of the secondary side feedback circuit a high CTR (CTR of 300 - 600%) optocoupler type was used. This reduces the secondary side opto-led current from ~3 mA to <~1 mA and therefore the effective load on the output. A standard 2.5 V TL431 voltage reference was replaced with the 1.24 V LMV431 to reduce the supply current requirement of this component from 1 mA to 100  $\mu$ A

- 4.1.6 Output Rectifier Choice
- Use of high  $V_{\text{OR}}$  enabled the use of a 60 V Schottky diode for high efficiency and lower cost

The higher  $BV_{DSS}$  rating of the TOPSwitch-JX of 725 V (compared to 600 V or 650 V rating of typical power MOSFETs) allowed a higher transformer primary to secondary turns ratio (reflected output voltage or  $V_{OR}$ ). This reduced the output diode voltage stress and allowed the use of cheaper and more efficient 60 V (vs 80 V or 100 V) Schottky diodes. The efficiency improvement occurs due the lower forward voltage drop of the lower voltage diodes. Two parallel connected axial 5 A, 60 V Schottky rectifier diodes were selected for both low cost and high efficiency. This allowed PCB heatsinking of the diode for low cost while maintaining efficiency compared to a single higher current TO-220 packaged diode mounted on a heatsink. For this configuration the recommendation is that each diode is rated at twice the output current and that the diodes share a common cathode PCB area for heatsinking so that their temperatures track. In practice the diodes current share quite effectively as can be demonstrated by monitoring their individual temperatures.



### 4.2 Function Block Descriptions

### 4.2.1 Input EMI Filtering

Common-mode inductors L1 and X capacitor C1 provides CM and DM noise filtering. The frequency jittering feature of the TOPSwitch-JX allows a very small X capacitor (100 nF) to be used in meeting Class B Emission limits. This also eliminates the need for discharge resistors required for meeting safety standards.

Y capacitor C11, connected between the primary and secondary side in conjunction with T1 shield and cancellation windings provides common mode filtering.

#### 4.2.2 TOPSwitch-JX Primary

The EcoSmart feature of U1 automatically provides constant efficiency over the entire load range. It uses a proprietary Multi-Cycle-Modulation (MCM) function to eliminate the need for special operating modes triggered at specific loads. This simplifies circuit design since it removes the need to design for aberrant or specific operating conditions or load thresholds.

Capacitor C10 provides the auto-restart timing for U1. At startup this capacitor is charged through the DRAIN (D) pin. Once it is charged U1 begins to switch. Capacitor C10 stores enough energy to ensure the power supply starts up. After start-up the bias winding powers the controller via the CONTROL pin. Bypass capacitor C9 is placed as physically close as possible to U1. Resistor R16 provides additional compensation to the feedback loop.

#### 4.2.3 Thermal Overload Protection

IC U1 has an integrated accurate hysteretic thermal overload protection function. When the junction temperature of U1 reaches +142 °C (typical temperature shutdown threshold) during a fault condition, the IC shuts down. It automatically recovers once the junction temperature has decreased by 75 °C.

#### 4.2.4 Output Overvoltage Protection

Open-loop faults cause the output voltage to exceed the specified maximum value. To prevent excessive output voltage levels in such cases, U1 utilizes an output overvoltage shutdown function. An increase in output voltage causes an increase in the bias winding on the primary side, sensed by VR3. A sufficient rise in the bias voltage causes VR3 to conduct and inject current into the VOLTAGE (V) pin of U1. When the current exceeds 336  $\mu$ A for more than 100  $\mu$ s, U1 enters the latching overvoltage shutdown mode.

### 4.2.5 Output Power Limiting with Line Voltage

Resistors R3, R4, and R15 reduce the external current limit of U1 as the line voltage increases. This allows the supply to limit the output power to <100 VA at high line while still delivering the rated output at low line, and to provide a nearly constant output power level with changing line voltages. The line sensing resistors R1 and R2, in conjunction with R12, set the undervoltage and overvoltage thresholds for U1. R12 provides



additional current to V pin from the bias supply and together with R1 and R2 sets the threshold current for V pin with reduced power loss and thus helps further improvement on the no-load input power.

#### 4.2.6 Output Feedback

Schottky diodes D8 and D9 rectify the output. A snubber network (C12, R17) dampens ringing across the diodes and reduces high frequency conducted and radiated noise. Capacitors C14 and C15 provide output filtering. Resistors R21 and R23 provide a voltage divider and set the DC set point of the output. C20, R21, and R19 provide compensation for the feedback control loop and C18 and R18 is a phase boost network to improve the phase margin of the unit. Resistor R19 limits the gain of the feedback system to ensure power supply stability throughout the range of operation. Diode D10 provides a fast discharge path for C20 when the output turns-off and to allow smooth rise of the output voltage when the unit is turned on again.

### 4.2.7 Output Inductor Post Filter Soft-Finish

To prevent output overshoot during start-up the voltage that appears across L2 was used to provide a soft-finish function. When the voltage across L2 exceeds the forward drop of U2A and D10 current flows though the optocoupler LED and provides feedback to the primary. This arrangement acts to limit the rate of rise of the output voltage until it reaches regulation and eliminates the capacitor that is typically placed across U3 to provide the same function.



# 5 PCB Layout

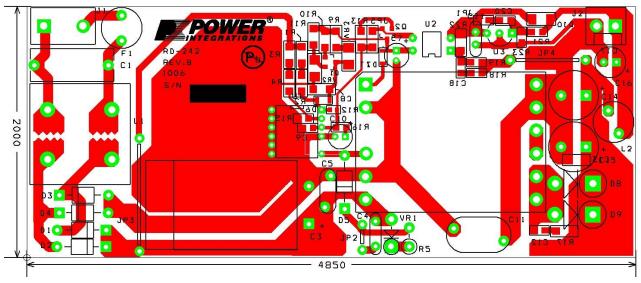


Figure 4 – Printed Circuit Board Layout.



# 6 Bill of Materials

|      |     | Ref            |   |                    |                      |
|------|-----|----------------|---|--------------------|----------------------|
| Item | Qty | Des            | Description   | Part Number        | Mfg                  |
| 1    | 1   | C1             | 100 nF, 275VAC, Film, X2  | LE104              | OKAYA ELECT          |
| 2    | 1   | C3             | 82 $\mu\text{F},$ 400 V, Electrolytic, Low ESR, (18 x 25)                     | EKXG401ELL820MM25S | Nippon Chemi-<br>Con |
| 3    | 1   | C4             | 4700 pF, 1 kV, Disc Ceramic   | 562R5GAD47         | Vishay               |
| 4    |     | C5             | Not Used  |                    |                      |
| 5    | 2   | C7,<br>C10     | 47 $\mu F,$ 25 V, Electrolytic, Very Low ESR, 300 m $\Omega,$ (5 x 11)        | EKZE250ELL470ME11D | Nippon Chemi-<br>Con |
| 6    |     | C8             | Not Used  |                    |                      |
| 7    | 1   | C9             | 100 nF, 50 V, Ceramic, X7R, 0805  | ECJ-2YB1H104K      | Panasonic            |
| 8    | 1   | C11            | 1 nF, Ceramic, Y1   | 440LD10-R          | Vishay               |
| 9    | 1   | C12            | 1 nF, 200 V, Ceramic, X7R, 0805   | 08052C102KAT2A     | AVX Corp             |
| 10   |     | C13<br>C17     | Not Used  |                    |                      |
| 11   | 2   | C14<br>C15     | 680 $\mu\text{F},$ 25 V, Electrolytic, Very Low ESR, 23 m $\Omega,$ (10 x 20) | EKZE250ELL681MJ20S | Nippon Chemi-<br>Con |
| 12   | 1   | C16            | 100 $\mu F,$ 25 V, Electrolytic, Gen. Purpose, (6.3 x 11)                     | EKMG250ELL101MF11D | Nippon Chemi-<br>Con |
| 13   | 1   | C18            | 47 nF, 50 V, Ceramic, X7R, 0805   | ECJ-2YB1H473K      | Panasonic            |
| 14   | 1   | C20            | 33 nF, 50 V, Ceramic, X7R, 0805   | ECJ-2VB1H333K      | Panasonic            |
| 15   |     | C21            | Not Used  |                    |                      |
| 16   | 4   | D1 D2<br>D3 D4 | 1000 V, 1 A, Rectifier, DO-41   | 1N4007-E3/54       | Vishay               |
| 17   | 1   | D5             | Rectifiers 1A 1000 V 150ns  | FR107G-B           | Rectron              |
| 18   | 1   | D6             | 100 V, 0.2 A, Fast Switching, 50 ns, SOD-323                                  | BAV19WS-7-F        | Diode Inc.           |
| 19   | 1   | D7             | 250 V, 0.2 A, Fast Switching, 50 ns, SOD-323                                  | BAV21WS-7-F        | Diode Inc.           |
| 20   | 2   | D8 D9          | 60 V, 5 A, Schottky, DO-201AD   | SB560              | Vishay               |
| 21   | 1   | D10            | 75 V, 0.15 A, Fast Switching, 4 ns, MELF                                      | LL4148-13          | Diode Inc.           |
| 22   | 1   | F1             | 3.15 A, 250 V, Slow, TR5  | 3721315041         | Wickman              |
| 23   | 1   | J1             | 3 Position (1 x 3) header, 0.156 pitch, Vertical                              | 26-48-1031         | Molex                |
| 24   | 1   | J2             | 2 Position (1 x 2) header, 0.156 pitch, Vertical                              | 26-48-1021         | Molex                |
| 25   | 1   | JP1            | 0 R, 5%, 1/8 W, Thick Film, 0805  | ERJ-6GEY0R00V      | Panasonic            |
| 26   | 1   | JP2            | Wire Jumper, Non insulated, 22 AWG, 0.2 in                                    | 298 SV005          | Alpha                |
| 27   | 1   | JP3            | Wire Jumper, Non insulated, 22 AWG, 0.9 in                                    | 298 SV005          | Alpha                |
| 28   | 1   | JP4            | Wire Jumper, Non insulated, 22 AWG, 0.6 in                                    | 298 SV005          | Alpha                |
| 29   | 1   | JP5            | 0 R, 5%, 1/8 W, Thick Film, 0805  | ERJ-6GEY0R00V      | Panasonic            |
| 30   | 1   | L1             | 14 mH, 0.7 A, Common Mode Choke   | ELF-17N007A        | Panasonic            |
| 31   | 1   | L2             | 3.3 μH, 5.5 A   | RL622-3R3K-RC      | JW Miller            |
| 32   |     | Q1             | Not Used  |                    |                      |
| 33   |     | Q2             | Not Used  |                    |                      |
| 34   | 2   | R1 R2          | 5.1 MΩ, 5%, 1/4 W, Thick Film, 1206   | ERJ-8GEYJ515V      | Panasonic            |
| 35   | 2   | R3 R4          | 10 MΩ, 5%, 1/4 W, Thick Film, 1206  | ERJ-8GEYJ106V      | Panasonic            |
| 36   | 1   | R5             | 10 kΩ, 5%, 1/2 W, Carbon Film   | CFR-50JB-10K       | Yageo                |
| 37   | 1   | R9             | 10 Ω, 5%, 1/4 W, Thick Film, 1206   | ERJ-8GEYJ100V      | Panasonic            |



| 38 |   | R10 | Not Used                               |                     |                           |
|----|---|-----|--|---------------------|---------------------------|
| 39 |   | R11 | Not Used                               |                     |                           |
| 40 | 1 | R12 | 191 kΩ, 1%, 1/16 W, Thick Film, 0603   | ERJ-3EKF1913V       | Panasonic                 |
| 41 |   | R13 | Not Used                               |                     |                           |
| 42 | 1 | R15 | 14.3 kΩ, 1%, 1/8 W, Thick Film, 0805   | ERJ-6ENF1432V       | Panasonic                 |
| 43 | 1 | R16 | 6.8 Ω, 5%, 1/8 W, Thick Film, 0805     | ERJ-6GEYJ6R8V       | Panasonic                 |
| 44 | 1 | R17 | 22 Ω, 5%, 1/4 W, Thick Film, 1206      | ERJ-8GEYJ220V       | Panasonic                 |
| 45 | 1 | R18 | 110 Ω, 5%, 1/8 W, Thick Film, 0805     | ERJ-6GEYJ111V       | Panasonic                 |
| 46 | 1 | R19 | 470 Ω, 5%, 1/8 W, Thick Film, 0805     | ERJ-6GEYJ470V       | Panasonic                 |
| 47 | 1 | R21 | 86.6 kΩ, 1%, 1/8 W, Thick Film, 0805   | ERJ-6ENF8662V       | Panasonic                 |
| 48 |   | R22 | Not Used                               |                     |                           |
| 59 | 1 | R23 | 10 kΩ, 1%, 1/8 W, Thick Film, 0805     | ERJ-6ENF1002V       | Panasonic                 |
| 50 | 1 | T1  | Bobbin, EF25, Horizontal, 12 pins      | YC2504<br>SNX-R1521 | Ying Chin<br>Santronics   |
| 51 | 1 | U1  | TOP266VG, eDIP-12P                     | TOP266VG            | Power<br>Integrations     |
| 52 | 1 | U2  | Optocoupler, 35 V, CTR 300-600%, 4-DIP | LTV-817D            | Liteon                    |
| 53 | 1 | U3  | 1.24V Shunt Reg IC                     | LMV431ACZ           | National<br>Semiconductor |
| 54 | 1 | VR1 | 180 V, 5 W, 5%, TVS, DO204AC (DO-15)   | P6KE180ARLG         | On Semi                   |
| 55 |   | VR2 | Not Used                               |                     |                           |
| 56 | 1 | VR3 | 15 V, 5%, 500 mW, DO-213AA (MELF)      | ZMM5245B-7          | Diodes Inc                |



# 7 Transformer Specification

### 7.1 Electrical Diagram

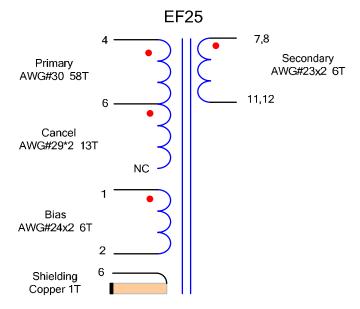


Figure 5 – Transformer Electrical Diagram.

### 7.2 Electrical Specifications

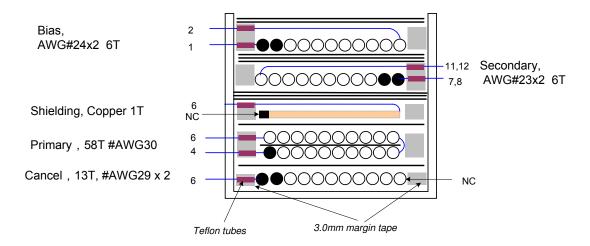
| Electrical Strength        | 1 second, 60 Hz, from pins 1-6 to pins 7-12                      | 3000 VAC             |
|----------------------------|--|----------------------|
| Primary Inductance         | Pins 4-6, all other windings open, measured at 100 kHz, 0.4 VRMS | 712 $\mu H \pm 10\%$ |
| Resonant Frequency         | Pins 4-6, all other windings open                                | 300 kHz (Min.)       |
| Primary Leakage Inductance | Pins 4-6, with pins 7-12 shorted, measured at 100 kHz, 0.4 VRMS  | 25 μH (Max.)         |

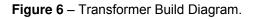
## 7.3 Materials

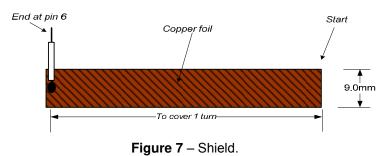
| Item | Description   |
|------|---|
| [1]  | Core: PC44 EF25, TDK or equivalent Gapped for AL of 215 nH/T <sup>2</sup>     |
| [2]  | Bobbin: BEF25, Horizontal, 12 pins, 6/6. Manufacture#: YC-2504.               |
| [3]  | Magnet Wire: #30 AWG.   |
| [4]  | Magnet Wire: #29 AWG  |
| [5]  | Magnet Wire: #23 AWG.   |
| [6]  | Magnet Wire: #24 AWG.   |
| [7]  | Margin tape: 3M, Polyester web. 3.0 mm wide.                                  |
| [8]  | Teflon Tube.  |
| [9]  | Tape: 3M 1298 Polyester Film, 15.3 mm wide.                                   |
| [10] | Tape: 3M 1298 Polyester Film, 9.3 mm wide.                                    |
| [11] | Tape: 3M 1298 Polyester Film, 14.0 mm wide.                                   |
| [12] | Copper Foil Tape: 2.0 mils thick, 9.0 mm wide. See Figure 7 below to prepare. |
| [13] | Varnish.  |



# 7.4 Transformer Build Diagram









| Mine alize at      | Diago the helphin item [2] on the mondral such that primary side on the left and   |
|--------------------|--|
| Winding            | Place the bobbin item [2] on the mandrel such that primary side on the left and  |
| preparation        | secondary side on the right. Winding direction is clockwise direction.   |
| Margin             | Apply margin tape item [7] on both sides of bobbin and for all windings.   |
| WD1                | Start at pin 6, apply Teflon tubes item [8] at start ends, wind 13 bifilar turns of item [4]   |
| (Cancel)           | from left to right. At the last turn, cut the wires and leave no connect.  |
| Insulation         | Apply 1 layer of tape item [9].  |
| WD2<br>(Primary)   | Start at pin 4, apply Teflon tube item [8] at start end, wind 29 turns of item [3] from left to right, place 1 layer of tape item [10]. Continue winding from right to left with another   |
| ( - )/             | 29 turns, at the last turn also apply Teflon tube item [8] and end at pin 6.   |
| Insulation         | Apply 1 layer of tape item [9].  |
| WD3<br>(Shielding) | Use copper foil tape item [12], see figure 3 above, start with no connect; wind 1 turn (over lapped- but separate with tape to avoid shortage), and end with pin 6.  |
| Insulation         | Apply 3 layers of tape item [8].   |
| WD4<br>(Secondary) | Start at pin 7, 8, apply Teflon tubes item [8] at start ends, wind 6 bifilar turns of item [5] from right to left, at the last turn bring the wires back to the left, also apply Teflon tubes at the wire ends, and finish at pin 11,12. |
| Insulation         | Apply 3 layers of tape item [9].   |
| WD5<br>(Bias)      | Start at pin 1, apply Teflon tubes item [8] at start ends, wind 6 bifilar turns of item [6] from left to right, at the last turn bring the wires back to the left, also apply Teflon tubes at the wire ends, and finish at pin 1.        |
| Outer insulation   | Apply 2 layers of tape item [9].   |
| Final Assembly     | Grind core. Cover outside the core with tape item [11]. Assemble core and varnish [13]   |
| -                  |  |

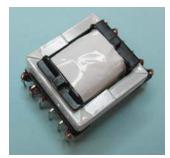


Figure 8 – Completed Transformer.



# 8 Transformer Design Spreadsheet

| ACDC_TOPSwitchJX_020<br>110; Rev.1.2; Copyright   |               | INFO    | OUTPUT    | 115.07              | TOP_JX_020110: TOPSwitch-JX<br>Continuous/Discontinuous Flyback                               |
|---|---------------|---------|-----------|---------------------|---|
| Power Integrations 2010<br>ENTER APPLICATION VARI |               | INFO    | OUTPUT    | UNIT                | Transformer Design Spreadsheet Design title   |
| VACMIN  | 85            |         | l .       | Volts               | Minimum AC Input Voltage  |
| VACMAX  | 265           |         |           | Volts               | Maximum AC Input Voltage  |
| fL  | 50            |         |           | Hertz               | AC Mains Frequency  |
| VO  | 12.00         |         |           | Volts               | Output Voltage (main)   |
| PO_AVG  | 30.00         | Warning |           | Watts               | III For low line (VMIN < 200 VDC) designs:  |
| PO_PEAK   |               |         | 30.00     | Watts               | Peak Output Power   |
| Heatsink Type                                     | PCB           |         | PCB       |                     | Heatsink Type   |
| Enclosure   | Open<br>Frame |         |           |                     | Open Frame enclosure assume sufficienct<br>airflow while adapter means a sealed<br>enclosure. |
| n   | 0.80          |         |           | %/100               | Efficiency Estimate   |
| Z   | 0.50          |         |           |                     | Loss Allocation Factor  |
| VB  | 15            |         |           | Volts               | Bias Voltage - Verify that VB is > 8 V at no<br>load and VMAX                                 |
| tC  | 3.00          |         |           | ms                  | Bridge Rectifier Conduction Time Estimate   |
| CIN   | 82.0          |         | 82        | uFarads             | Input Filter Capacitor  |
| ENTER TOPSWITCH-JX VA                             |               |         |           |                     |   |
| TOPSwitch-JX                                      | TOP266V       |         |           | Universal<br>/ Peak | 115 Doubled/230V  |
| Chosen Device                                     |               | TOP266V | Power Out | 28.5 W /<br>86 W    | 39W   |
| KI  | 0.4725        |         |           |                     | External Ilimit reduction factor (KI=1.0 for default ILIMIT, KI <1.0 for lower ILIMIT)        |
| ILIMITMIN_EXT                                     |               |         | 1.120     | Amps                | Use 1% resistor in setting external ILIMIT  |
| ILIMITMAX_EXT                                     |               |         | 1.289     | Amps                | Use 1% resistor in setting external ILIMIT  |
| Frequency (F)=132kHz,<br>(H)=66kHz                | F             |         | F         |                     | Select 'H' for Half frequency - 66kHz, or 'F'<br>for Full frequency - 132kHz                  |
| fS  |               |         | 132000    | Hertz               | TOPSwitch-JX Switching Frequency:<br>Choose between 132 kHz and 66 kHz                        |
| fSmin   |               |         | 119000    | Hertz               | TOPSwitch-JX Minimum Switching<br>Frequency   |
| fSmax   |               |         | 145000    | Hertz               | TOPSwitch-JX Maximum Switching<br>Frequency   |
| High Line Operating Mode                          |               |         | FF        |                     | Full Frequency, Jitter enabled  |
| VOR   | 120.00        |         |           | Volts               | Reflected Output Voltage  |
| VDS   |               |         | 10        | Volts               | TOPSwitch on-state Drain to Source Voltage  |
| VD  | 0.50          |         |           | Volts               | Output Winding Diode Forward Voltage<br>Drop  |
| VDB   | 0.70          |         |           | Volts               | Bias Winding Diode Forward Voltage Drop   |
| KP  | 0.62          |         |           |                     | Ripple to Peak Current Ratio (0.3 < KRP < 1.0 : 1.0< KDP<6.0)                                 |
| PROTECTION FEATURES                               |               |         |           | ·                   | ·   |
| LINE SENSING                                      |               |         |           |                     | V pin functionality   |



| VUV_STARTUP                    |            |                 | 95    | Volts  | Minimum DC Bus Voltage at which the<br>power supply will start-up   |  |
|--------------------------------|------------|-----------------|-------|--------|---|--|
| VOV_SHUTDOWN                   |            |                 | 445   | Volts  | Typical DC Bus Voltage at which power<br>supply will shut-down (Max)  |  |
| RLS                            |            |                 | 4.0   | M-ohms | Use two standard, 2 M-Ohm, 5% resistors in series for line sense functionality.   |  |
| OUTPUT OVERVOLTAGE             |            |                 |       |        | •   |  |
| VZ                             |            |                 | 27    | Volts  | Zener Diode rated voltage for Output<br>Overvoltage shutdown protection   |  |
| RZ                             |            |                 | 5.1   | k-ohms | Output OVP resistor. For latching shutdown use 20 ohm resistor instead  |  |
| OVERLOAD POWER<br>LIMITING     |            |                 |       |        | X pin functionality   |  |
| Overload Current Ratio at VMAX |            |                 | 1.2   |        | Enter the desired margin to current limit at VMAX. A value of 1.2 indicates that the current limit should be 20% higher than peak primary current at VMAX |  |
| Overload Current Ratio at VMIN |            |                 | 1.11  |        | Margin to current limit at low line.  |  |
| ILIMIT_EXT_VMIN                |            |                 | 1.01  | А      | Peak primary Current at VMIN  |  |
| ILIMIT_EXT_VMAX                |            |                 | 0.97  | А      | Peak Primary Current at VMAX  |  |
| RIL                            |            |                 | 12.88 | k-ohms | Current limit/Power Limiting resistor.  |  |
| RPL                            |            |                 | N/A   | M-ohms | Resistor not required. Use RIL resistor only  |  |
| ENTER TRANSFORMER CO           | RE/CONSTRU | JCTION VARI     | ABLES |        |   |  |
| Core Type                      | Auto       |                 | EF25  |        | Core Type   |  |
| Core                           |            | EF25            |       | P/N:   | PC40EF25-Z  |  |
| Bobbin                         |            | EF25_BO<br>BBIN |       | P/N:   | *   |  |
| AE                             |            |                 | 0.518 | cm^2   | Core Effective Cross Sectional Area   |  |
| LE                             |            |                 | 5.78  | cm     | Core Effective Path Length  |  |
| AL                             |            |                 | 2000  | nH/T^2 | Ungapped Core Effective Inductance  |  |
| BW                             |            |                 | 15.6  | mm     | Bobbin Physical Winding Width   |  |
| Μ                              | 0.00       |                 |       | mm     | Safety Margin Width (Half the Primary to<br>Secondary Creepage Distance)  |  |
| L                              | 2.00       |                 |       |        | Number of Primary Layers  |  |
| NS                             |            |                 | 6     |        | Number of Secondary Turns   |  |
| DC INPUT VOLTAGE PARA          | METERS     |                 |       |        |   |  |
| VMIN                           |            |                 | 90    | Volts  | Minimum DC Input Voltage  |  |
| VMAX                           |            |                 | 375   | Volts  | Maximum DC Input Voltage  |  |
| CURRENT WAVEFORM SH            | APE PARAME | TERS            |       |        | •   |  |
| DMAX                           |            |                 | 0.60  |        | Maximum Duty Cycle (calculated at PO_PEAK)  |  |
| IAVG                           |            |                 | 0.42  | Amps   | Average Primary Current (calculated at average output power)  |  |
| IP                             |            |                 | 1.01  | Amps   | Peak Primary Current (calculated at Peak output power)  |  |
| IR                             |            |                 | 0.63  | Amps   | Primary Ripple Current (calculated at average output power)   |  |
| IRMS                           |            |                 | 0.56  | Amps   | Primary RMS Current (calculated at average output power)  |  |



| LP                          |          | 1          | 712        | ullenries     | Drimany Inductoria   |  |
|-----------------------------|----------|------------|------------|---------------|--|--|
|                             | _        | _          |            | uHenries      | Primary Inductance   |  |
| LP Tolerance                |          |            | 10         |               | Tolerance of Primary Inductance  |  |
| NP                          |          |            | 58         |               | Primary Winding Number of Turns  |  |
| NB                          |          |            | 8          |               | Bias Winding Number of Turns   |  |
| ALG                         |          |            | 215        | nH/T^2        | Gapped Core Effective Inductance   |  |
| BM                          |          |            | 2412       | Gauss         | Maximum Flux Density at PO, VMIN<br>(BM<3000)  |  |
| BP                          |          |            | 3384       | Gauss         | Peak Flux Density (BP<4200) at ILIMITMAX<br>and LP_MAX. Note: Recommended values<br>for adapters and external power supplies<br><=3600 Gauss |  |
| BAC                         |          |            | 751        | Gauss         | AC Flux Density for Core Loss Curves (0.5 )<br>Peak to Peak)   |  |
| ur                          |          |            | 1776       |               | Relative Permeability of Ungapped Core   |  |
| LG                          |          |            | 0.27       | mm            | Gap Length (Lg > 0.1 mm)   |  |
| BWE                         |          |            | 31.2       | mm            | Effective Bobbin Width   |  |
| OD                          | 0.32     |            | 0.32       | mm            | Maximum Primary Wire Diameter including<br>insulation  |  |
| INS                         |          |            | 0.05       | mm            | Estimated Total Insulation Thickness (= 2 * film thickness)  |  |
| DIA                         |          |            | 0.27       | mm            | Bare conductor diameter  |  |
| AWG                         |          |            | 30         | AWG           | Primary Wire Gauge (Rounded to next smaller standard AWG value)  |  |
| СМ                          |          |            | 102        | Cmils         | Bare conductor effective area in circular mile   |  |
| СМА                         |          | Warning    | 182        | Cmils/A<br>mp | III INCREASE CMA>200 (increase L(primar layers),decrease NS,larger Core)   |  |
| Primary Current Density (J) |          |            | 11.00      | Amps/m<br>m^2 | III Decrease current density Use larger wire<br>diameter, increase L or increase core size.  |  |
| TRANSFORMER SECONDAF        | Y DESIGN | PARAMETERS | (SINGLE OU | TPUT EQUIV    | ALENT)   |  |
| Lumped parameters           |          |            | (          |               |  |  |
| ISP                         |          | 1          | 9.70       | Amps          | Peak Secondary Current   |  |
| ISRMS                       |          |            | 4.36       | Amps          | Secondary RMS Current  |  |
| IO_PEAK                     |          |            | 2.50       | Amps          | Secondary Peak Output Current  |  |
| 10                          |          |            | 2.50       | Amps          | Average Power Supply Output Current  |  |
| IRIPPLE                     |          |            | 3.57       | Amps          | Output Capacitor RMS Ripple Current  |  |
| CMS                         |          |            | 872        | Cmils         | Secondary Bare Conductor minimum circular mils   |  |
| AWGS                        |          |            | 20         | AWG           | Secondary Wire Gauge (Rounded up to nex<br>larger standard AWG value)  |  |
| DIAS                        |          |            | 0.81       | mm            | Secondary Minimum Bare Conductor<br>Diameter   |  |
| ODS                         |          |            | 2.60       | mm            | Secondary Maximum Outside Diameter for<br>Triple Insulated Wire  |  |
| INSS                        |          |            | 0.89       | mm            | Maximum Secondary Insulation Wall<br>Thickness   |  |



| VOLTAGE STRESS PARAMETERS |                            | •        |   |
|---------------------------|----------------------------|----------|---|
| VDRAIN                    | 611                        | Volts    | Maximum Drain Voltage Estimate (Includes<br>Effect of Leakage Inductance) |
| PIVS                      | 51                         | Volts    | Output Rectifier Maximum Peak Inverse Voltage                             |
| PIVB                      | 64                         | Volts    | Bias Rectifier Maximum Peak Inverse Voltage                               |
| TRANSFORMER SECONDARY DES | IGN PARAMETERS (MULTIPLE C | OUTPUTS) |   |
| 1st output                |                            |          |   |
| VO1                       | 12                         | Volts    | Output Voltage  |
| IO1_AVG                   | 2.50                       | Amps     | Average DC Output Current   |
| PO1_AVG                   | 30.00                      | Watts    | Average Output Power  |
| VD1                       | 0.5                        | Volts    | Output Diode Forward Voltage Drop   |
| NS1                       | 6.00                       |          | Output Winding Number of Turns  |
| ISRMS1                    | 4.361                      | Amps     | Output Winding RMS Current  |
| RIPPLE1                   | 3.57                       | Amps     | Output Capacitor RMS Ripple Current                                       |
| PIVS1                     | 51                         | Volts    | Output Rectifier Maximum Peak Inverse<br>Voltage                          |
| CMS1                      | 872                        | Cmils    | Output Winding Bare Conductor minimum circular mils                       |
| AWGS1                     | 20                         | AWG      | Wire Gauge (Rounded up to next larger standard AWG value)                 |
| DIAS1                     | 0.81                       | mm       | Minimum Bare Conductor Diameter   |
| ODS1                      | 2.60                       | mm       | Maximum Outside Diameter for Triple<br>Insulated Wire                     |
| 2nd output                |                            |          |   |
| VO2                       |                            | Volts    | Output Voltage  |
| IO2_AVG                   |                            | Amps     | Average DC Output Current   |
| PO2_AVG                   | 0.00                       | Watts    | Average Output Power  |
| VD2                       | 0.7                        | Volts    | Output Diode Forward Voltage Drop   |
| NS2                       | 0.34                       |          | Output Winding Number of Turns  |
| ISRMS2                    | 0.000                      | Amps     | Output Winding RMS Current  |
| IRIPPLE2                  | 0.00                       | Amps     | Output Capacitor RMS Ripple Current                                       |
| PIVS2                     | 2                          | Volts    | Output Rectifier Maximum Peak Inverse Voltage                             |
| CMS2                      | 0                          | Cmils    | Output Winding Bare Conductor minimum circular mils                       |
| AWGS2                     | N/A                        | AWG      | Wire Gauge (Rounded up to next larger standard AWG value)                 |
| DIAS2                     | N/A                        | mm       | Minimum Bare Conductor Diameter   |
| ODS2                      | N/A                        | mm       | Maximum Outside Diameter for Triple<br>Insulated Wire                     |
| 3rd output                |                            |          |   |
| VO3                       |                            | Volts    | Output Voltage  |
| IO3_AVG                   |                            | Amps     | Average DC Output Current   |
| PO3_AVG                   | 0.00                       | Watts    | Average Output Power  |
| VD3                       | 0.7                        | Volts    | Output Diode Forward Voltage Drop   |
| NS3                       | 0.34                       |          | Output Winding Number of Turns  |
| ISRMS3                    | 0.000                      | Amps     | Output Winding RMS Current  |
| IRIPPLE3                  | 0.00                       | Amps     | Output Capacitor RMS Ripple Current                                       |
| PIVS3                     | 2                          | Volts    | Output Rectifier Maximum Peak Inverse<br>Voltage                          |



| CMS3                             | 0   | Cmils | Output Winding Bare Conductor minimum<br>circular mils                                      |
|----------------------------------|-----|-------|---|
| AWGS3                            | N/A | AWG   | Wire Gauge (Rounded up to next larger standard AWG value)                                   |
| DIAS3                            | N/A | mm    | Minimum Bare Conductor Diameter   |
| ODS3                             | N/A | mm    | Maximum Outside Diameter for Triple<br>Insulated Wire                                       |
| Total Continuous Output<br>Power | 30  | Watts | Total Continuous Output Power   |
| Negative Output                  | N/A |       | If negative output exists enter Output<br>number; eg: If VO2 is negative output, enter<br>2 |

Note: The warning displayed for PO\_AVG indicates the possibility of a thermal issue however thermal results showed that the selected device could deliver the rated output power at the specified maximum ambient temperature.



# 9 Performance Data

All measurements were performed at room temperature, 60 Hz input frequency. All output measurements were taken at the output terminals.

# 9.1 Active Mode Efficiency

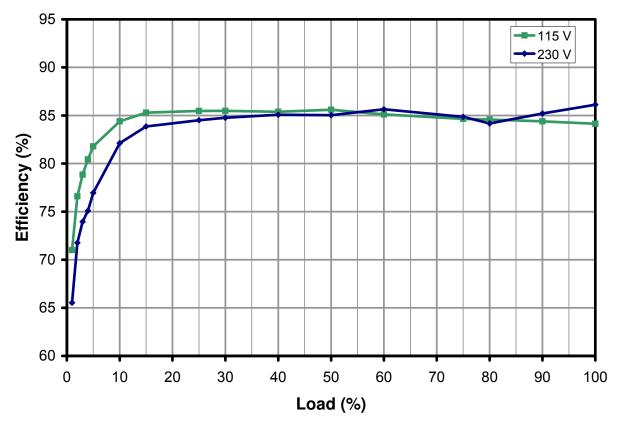


Figure 9 – Efficiency vs. Input Voltage, Room Temperature, 60 Hz.



| Load (%) | I <sub>OUT</sub> (Meas) | V <sub>OUT</sub> (V) | P <sub>OUT</sub> (W) | P <sub>IN</sub> (W) | Efficiency (%) |
|----------|-------------------------|----------------------|----------------------|---------------------|----------------|
| 0        | 0.000                   | 11.99                | 0.0000               | 0.062               |                |
| 1        | 0.025                   | 11.99                | 0.30                 | 0.423               | 71.00          |
| 2        | 0.050                   | 11.98                | 0.60                 | 0.782               | 76.60          |
| 3        | 0.075                   | 11.98                | 0.90                 | 1.141               | 78.85          |
| 4        | 0.100                   | 11.98                | 1.20                 | 1.491               | 80.43          |
| 5        | 0.125                   | 11.98                | 1.50                 | 1.831               | 81.79          |
| 10       | 0.250                   | 11.98                | 3.00                 | 3.549               | 84.39          |
| 15       | 0.375                   | 11.98                | 4.49                 | 5.267               | 85.30          |
| 25       | 0.625                   | 11.98                | 7.49                 | 8.760               | 85.47          |
| 30       | 0.750                   | 11.98                | 8.99                 | 10.510              | 85.49          |
| 40       | 1.000                   | 11.98                | 11.98                | 14.030              | 85.39          |
| 50       | 1.249                   | 11.98                | 14.96                | 17.480              | 85.60          |
| 60       | 1.499                   | 11.98                | 17.96                | 21.100              | 85.11          |
| 75       | 1.876                   | 11.98                | 22.47                | 26.550              | 84.65          |
| 80       | 2.005                   | 11.98                | 24.02                | 28.400              | 84.58          |
| 90       | 2.250                   | 11.98                | 26.96                | 31.940              | 84.39          |
| 100      | 2.499                   | 11.98                | 29.94                | 35.580              | 84.14          |

Table 1 – Data at 115 VAC / 60 Hz for Figure 9.

| Load (%) | I <sub>OUT</sub> (Meas) | V <sub>OUT</sub> (V) | P <sub>OUT</sub> (W) | P <sub>IN</sub> (W) | Efficiency (%) |
|----------|-------------------------|----------------------|----------------------|---------------------|----------------|
| 0        | 0.000                   | 11.99                | 0.0000               | 0.075               |                |
| 1        | 0.025                   | 11.99                | 0.30                 | 0.456               | 65.52          |
| 2        | 0.050                   | 11.99                | 0.60                 | 0.837               | 71.77          |
| 3        | 0.075                   | 11.99                | 0.90                 | 1.216               | 73.95          |
| 4        | 0.100                   | 11.98                | 1.20                 | 1.600               | 75.10          |
| 5        | 0.125                   | 11.98                | 1.50                 | 1.946               | 76.95          |
| 10       | 0.250                   | 11.98                | 3.00                 | 3.647               | 82.12          |
| 15       | 0.375                   | 11.98                | 4.49                 | 5.357               | 83.86          |
| 25       | 0.625                   | 11.98                | 7.49                 | 8.860               | 84.51          |
| 30       | 0.750                   | 11.98                | 8.99                 | 10.600              | 84.76          |
| 40       | 1.000                   | 11.98                | 11.98                | 14.080              | 85.09          |
| 50       | 1.250                   | 11.98                | 14.98                | 17.610              | 85.04          |
| 60       | 1.500                   | 11.98                | 17.97                | 20.980              | 85.65          |
| 75       | 1.875                   | 11.98                | 22.46                | 26.470              | 84.86          |
| 80       | 1.999                   | 11.98                | 23.95                | 28.450              | 84.18          |
| 90       | 2.249                   | 11.98                | 26.94                | 31.620              | 85.21          |
| 100      | 2.499                   | 11.98                | 29.94                | 34.760              | 86.13          |

Table 2 – Data at 230 VAC / 50 Hz for Figure 9.



| Percent of Full<br>Load        | Efficier | ncy (%) |
|--------------------------------|----------|---------|
|                                | 115 VAC  | 230 VAC |
| 25                             | 85.47    | 84.51   |
| 50                             | 85.60    | 85.04   |
| 75                             | 84.65    | 84.86   |
| 100                            | 84.14    | 86.13   |
| Average                        | 84.97    | 85.13   |
| US EISA (2007)<br>requirement  | 8        | 1       |
| ENERGY STAR 2.0<br>requirement | 8        | 3       |



### 9.2 Energy Efficiency Requirements

The external power supply requirements below all require meeting active mode efficiency and no-load input power limits. Minimum active mode efficiency is defined as the average efficiency of 25, 50, 75 and 100% of output current (based on the nameplate output current rating).

For adapters that are single input voltage only then the measurement is made at the rated single nominal input voltage (115 VAC or 230 VAC), for universal input adapters the measurement is made at both nominal input voltages (115 VAC and 230 VAC).

To meet the standard the measured average efficiency (or efficiencies for universal input supplies) must be greater than or equal to the efficiency specified by the standard.

The test method can be found here:

<u>http://www.energystar.gov/ia/partners/prod\_development/downloads/power\_supplies/EP</u> <u>SupplyEffic\_TestMethod\_0804.pdf</u>

For the latest up to date information please visit the PI Green Room:

http://www.powerint.com/greenroom/regulations.htm

### 9.2.1 USA Energy Independence and Security Act 2007

This legislation mandates all single output single output adapters, including those provided with products, manufactured on or after July 1<sup>st</sup>, 2008 must meet minimum active mode efficiency and no load input power limits.

Active Mode Efficiency Standard Models

| Nameplate Output (Po)     | Minimum Efficiency in Active Mode of Operation |
|---------------------------|--|
| < 1 W                     | $0.5 \times P_0$                               |
| $\geq$ 1 W to $\leq$ 51 W | 0.09 × In (P <sub>o</sub> ) + 0.5              |
| > 51 W                    | 0.85   |

In = natural logarithm

No-load Energy Consumption

| Nameplate Output (Po) | Maximum Power for No-load AC-DC EPS |
|-----------------------|-------------------------------------|
| All                   | $\leq$ 0.5 W                        |

This requirement supersedes the legislation from individual US States (for example CEC in California).



### 9.2.2 ENERGY STAR EPS Version 2.0

This specification takes effect on November 1<sup>st</sup>, 2008.

Active Mode Efficiency Standard Models

| Nameplate Output (P <sub>o</sub> ) | Minimum Efficiency in Active Mode of Operation           |
|------------------------------------|--|
| ≤ 1 W                              | 0.48 × P <sub>0</sub> + 0.14                             |
| > 1 W to $\leq$ 49 W               | 0.0626 × ln (P <sub>o</sub> ) + 0.622                    |
| > 49 W                             | 0.87   |
|                                    | he is a first of the second data and the second data and |

In = natural logarithm

Active Mode Efficiency Low Voltage Models (V<sub>O</sub><6 V and I<sub>O</sub>  $\ge$  550 mA)

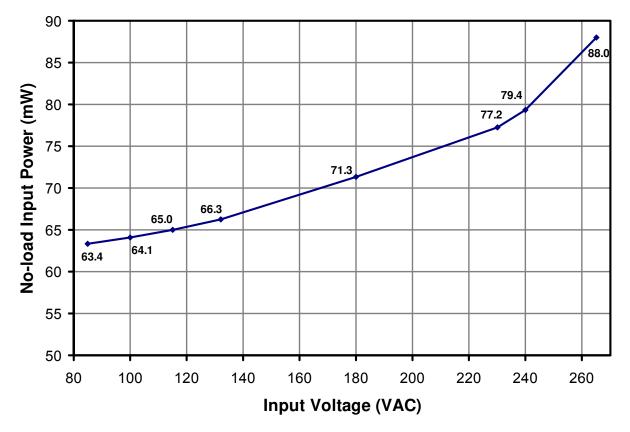
| Nameplate Output (P <sub>0</sub> ) | Minimum Efficiency in Active Mode of Operation |
|------------------------------------|--|
| $\leq$ 1 W                         | $0.497 \times P_{O} + 0.067$                   |
| $>$ 1 W to $\leq$ 49 W             | 0.075 × ln (P <sub>o</sub> ) + 0.561           |
| > 49 W                             | 0.86   |
|                                    |  |

In = natural logarithm

No-load Energy Consumption (both models)

| Nameplate Output (Po)       | Maximum Power for No-load AC-DC EPS |
|-----------------------------|-------------------------------------|
| 0 to < 50 W                 | $\leq$ 0.3 W                        |
| $\geq 50$ W to $\leq 250$ W | $\leq$ 0.5 W                        |





# 9.3 No-load Input Power

Figure 10 – Zero Load Input Power vs. Input Line Voltage, Room Temperature, 60 Hz.

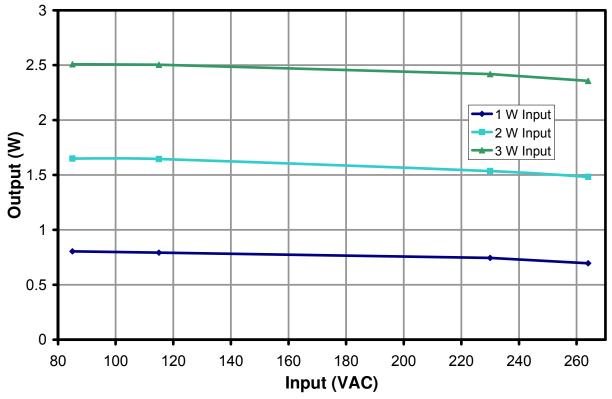
| V <sub>OUT</sub> | Input Line    | P <sub>IN</sub> (mW) |  |
|------------------|---------------|----------------------|--|
| 12               | 85 V / 50 Hz  | 63.36                |  |
| 12               | 100 V / 50 Hz | 64.10                |  |
| 12               | 115 V / 60 Hz | 65.00                |  |
| 12               | 132 V / 60 Hz | 66.27                |  |
| 12               | 180 V / 50 Hz | 71.33                |  |
| 12               | 230 V / 50 Hz | 77.23                |  |
| 12               | 240 V / 50 Hz | 79.36                |  |
| 12               | 264 V / 50 Hz | 88.03                |  |

 Table 3 – No-load Input Power vs. Input Voltage.



### 9.4 Available Standby Output Power

The chart below shows the available output power vs. line voltage for an input power of 1 W, 2 W and 3 W.



**Figure 11** – Available Standby Power.



# 9.5 Regulation

### 9.5.1 Load

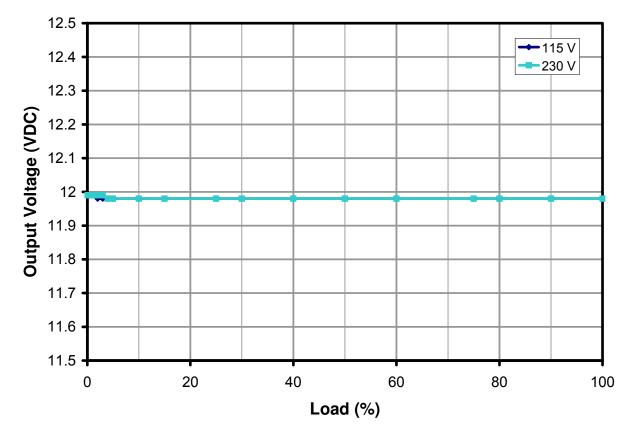
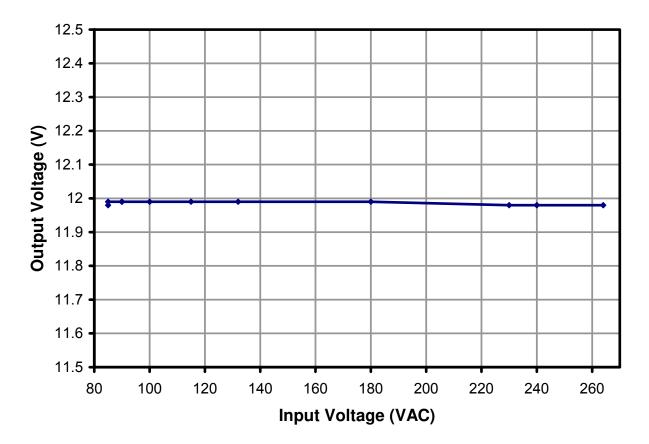


Figure 12 – Load Regulation, Room Temperature.





9.5.2 Line

Figure 13 – Line Regulation, Room Temperature, Full Load.



# 9.6 Efficiency



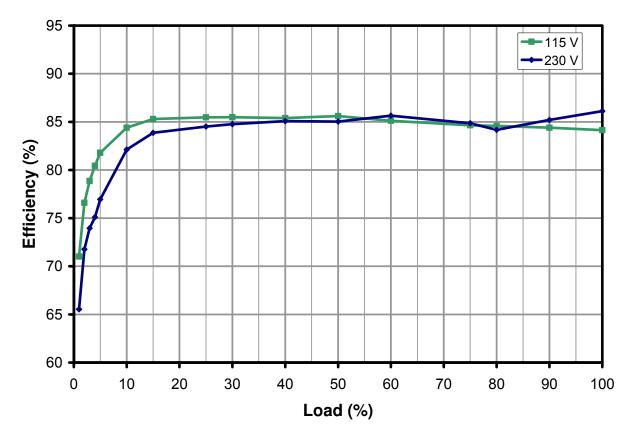


Figure 14 – Load Efficiency, Room Temperature.



10.6.2 Line

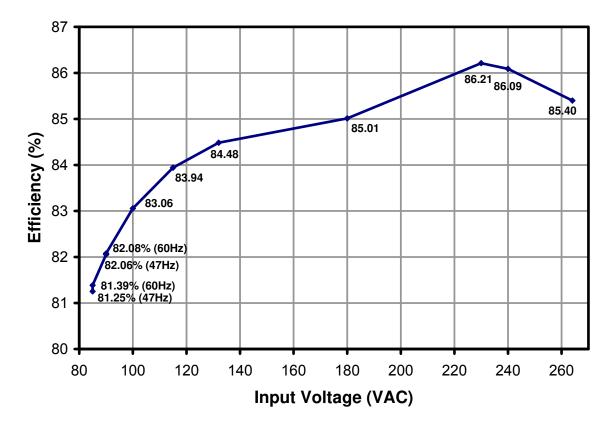


Figure 15 – Line Efficiency at Full-load, Room Temperature.



# **10 Power Limit**

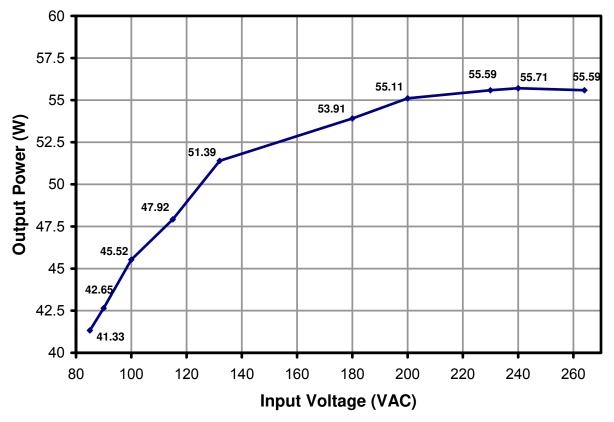


Figure 16 – Maximum Output Power vs. Line Voltage.



# **11 Thermal Performance**

The power supply was placed inside a small box and then placed inside the chamber. The box protects the unit from being blown directly by the fan inside the chamber. The chamber temperature was controlled to maintain a constant temperature of 40 °C inside the box. The supply was operated at its rated output power (30 W). The transformer winding temperature was taken on the outermost layer.

| Item | Ref<br>Des | Description            | 85 VAC, 47 Hz;<br>T <sub>A</sub> = 40 °C | 264 VAC, 50 Hz;<br>T <sub>A</sub> = 40 °C |
|------|------------|------------------------|--|---|
| 1    | L1         | Common Mode Choke Core | 81                                       | 52  |
| 2    | L1         | Common Mode Choke Wire | 92                                       | 54  |
| 3    | D1         | Bridge Diode           | 79                                       | 54  |
| 4    | U1         | TOPSwitch              | 107                                      | 78  |
| 5    | T1         | Transformer wire       | 86                                       | 82  |
| 6    | T1         | Transformer core       | 75                                       | 74  |
| 7    | C14        | Output Capacitor       | 54                                       | 54  |
| 8    | C15        | Output Capacitor       | 61                                       | 60  |
| 9    | D8         | Output Diode           | 81                                       | 80  |
| 10   | D9         | Output Diode           | 80                                       | 80  |
| 11   | VR1        | Zener Clamp            | 70                                       | 63  |



Norma 1

54\$/dia

500MS/s

Ţ

211.753m

∃0500k Norma1 500MS∕s

54\$/diu

Rms (C2) 346.251mV

Avg (C2)

Upper: V<sub>DRAIN</sub>, 100 V / div. Lower:  $I_{DRAIN}$ , 0.2 A, 5  $\mu$ s / div.

Avg (C2)

89.7719mV

Rms (C2) 226.977mV

Figure 18 – 115 VAC 60 Hz, Full Load.

ΠE

69

2010/01/06 17:03:48 🕃 Stopped 93

Stopped

Max (C1)

387.500

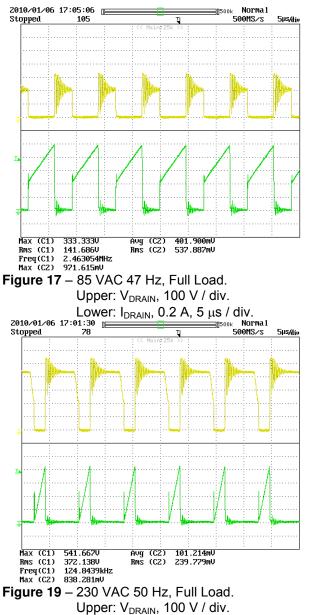
Rms (C1) 212.739V Freq(C1) 271.8869kHz

Max (C2) 846.615mV

2010/01/06 17:00:08

Stopped

# **12 Waveforms**



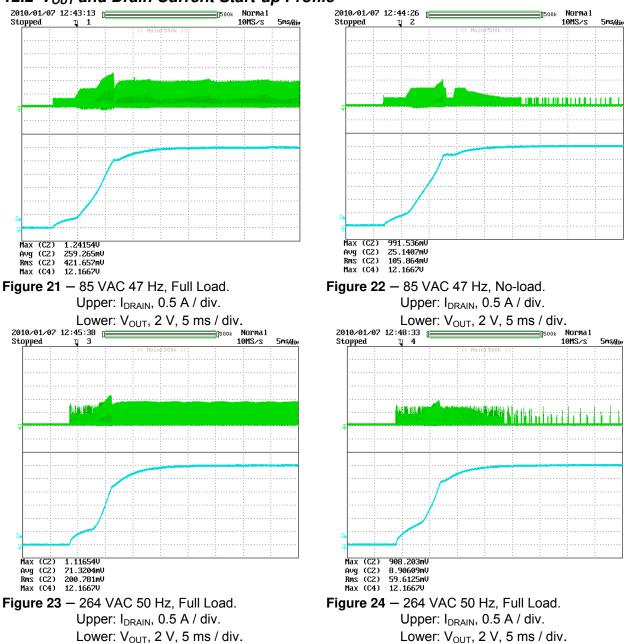
# 12.1 Drain Voltage and Current, Normal Operation



Max (C1)

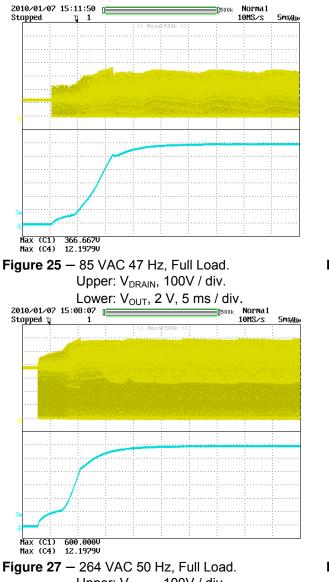
591.667V





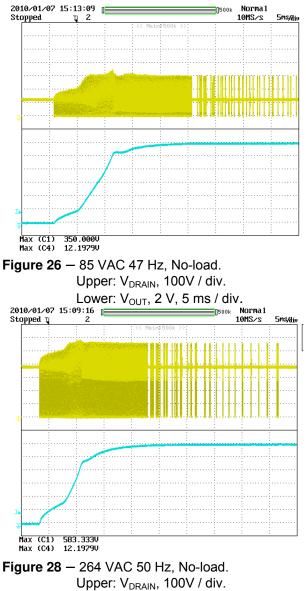
### 12.2 VOUT and Drain Current Start-up Profile





# 12.3 VOUT and Drain Voltage Start-up Profile

gure 27 – 264 VAC 50 Hz, Full Load. Upper: V<sub>DRAIN</sub>, 100V / div. Lower: V<sub>OUT</sub>, 2 V, 5 ms / div.

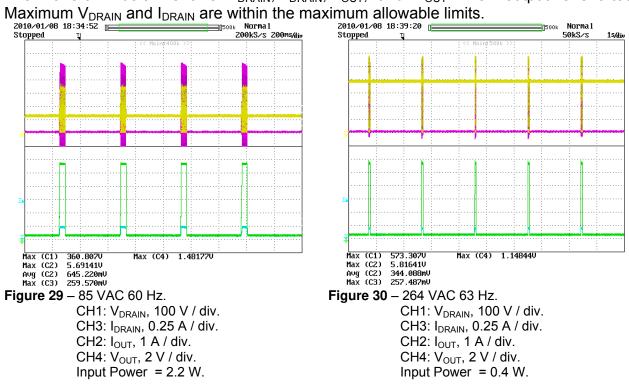


Lower: V<sub>DRAIN</sub>, 100V / div.



# 12.4 Over Current Protection

The waveform below shows  $V_{DRAIN}$ ,  $I_{DRAIN}$ ,  $I_{OUT}$ , and  $V_{OUT}$  when output is shorted.



The output diodes had the highest recorded temperature during an output short circuit at 85 VAC, 60 Hz (input power of 2.2 W). A temperature of 45 °C was well within the temperature limits of the diodes.

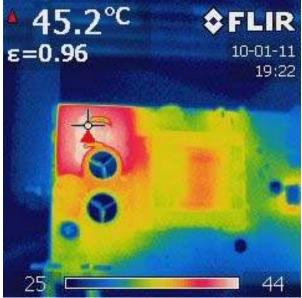
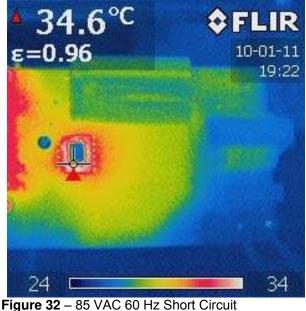


Figure 31 – 85 VAC 60 Hz Short Circuit D8, D9 : 45.2°C (T<sub>A</sub> = 25°C).



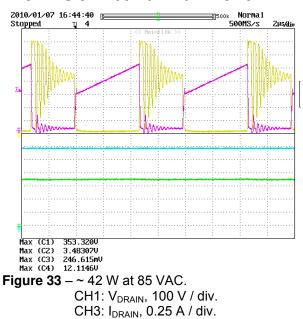
U1 : 34.6°C (T<sub>A</sub> = 25°C).



Norma1 500MS∕s

Zµs/diu

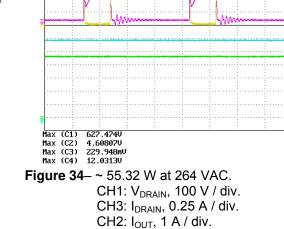
2010/01/07 16:47:45 Stopped **U**108



CH2: I<sub>OUT</sub>, 1 A / div.

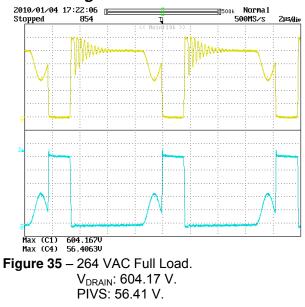
CH4: V<sub>OUT</sub>, 2 V / div.

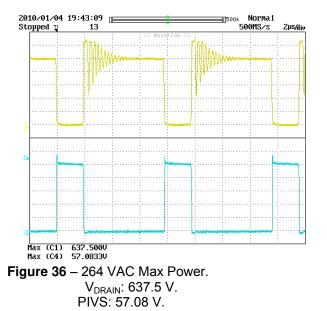




CH4: V<sub>OUT</sub>, 2 V / div.

12.6 Voltage Stress

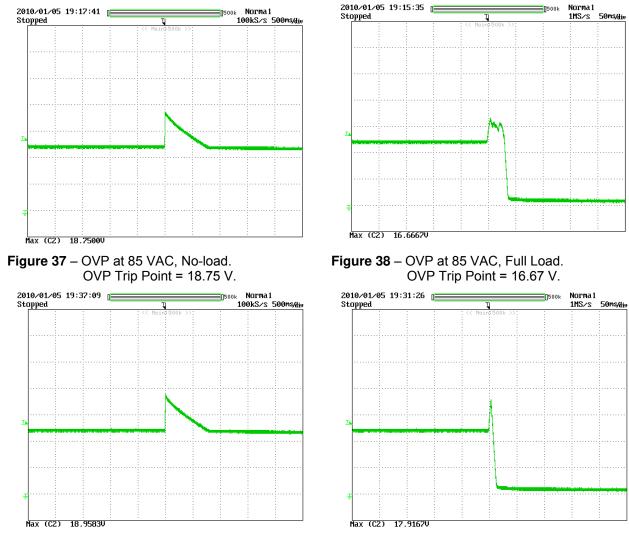


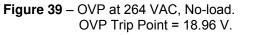


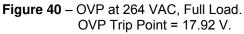


# 12.7 Overvoltage Protection (Open Loop Test)

OVP is initiated by shorting the LED of U2. This constitutes an open loop condition and causes the output voltage, and bias voltage to rise. OVP is sensed in the primary by sensing the bias winding.



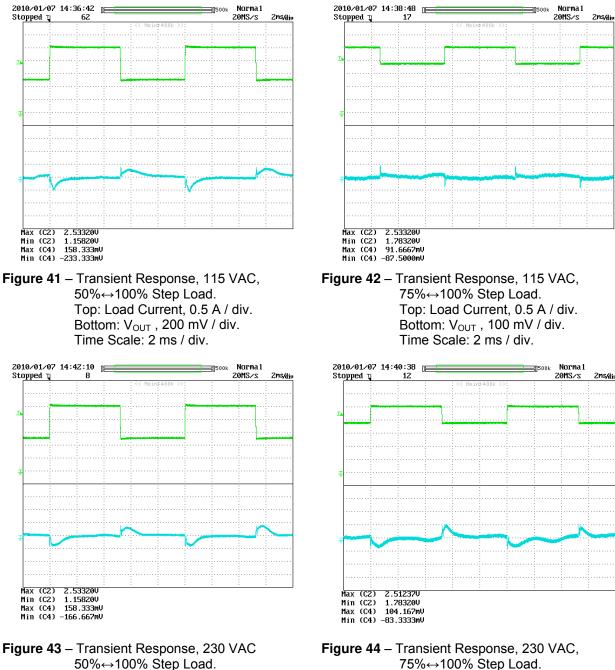






## 12.8 Load Transient Response

In the figures shown below, the output was AC coupled to view the load transient response. The oscilloscope was triggered using the load current step as a trigger source.



50%↔100% Step Load. Top: Load Current, 0.5 A / div. Bottom: V<sub>OUT</sub>, 200 mV / div. Time Scale: 2 ms / div.

Time Scale: 2 ms / div.

Top: Load Current, 0.5 A / div. Bottom:  $V_{OUT}$ , 100 mV / div.



### 12.9 Output Ripple Measurements

### 12.9.1 Ripple Measurement Technique

For DC output ripple measurements, a modified oscilloscope test probe must be utilized in order to reduce spurious signals due to pickup. Details of the probe modification are provided in the Figures below.

The 4987BA probe adapter is affixed with two capacitors tied in parallel across the probe tip. The capacitors include one (1) 0.1  $\mu$ F / 50 V ceramic type and one (1) 47.0  $\mu$ F / 50 V aluminum electrolytic. The aluminum electrolytic type capacitor is polarized, so proper polarity across DC outputs must be maintained (see below).

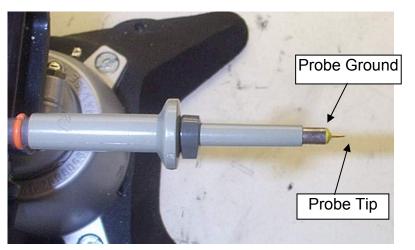
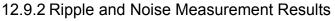


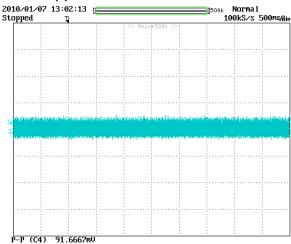
Figure 45 – Oscilloscope Probe Prepared for Ripple Measurement. (End Cap and Ground Lead Removed)

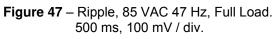


Figure 46 – Oscilloscope Probe with Probe Master (<u>www.probemaster.com</u>) 4987A BNC Adapter. (Modified with wires for ripple measurement, and two parallel decoupling capacitors added)









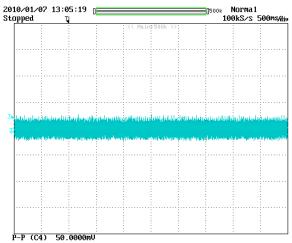


Figure 49 – Ripple, 264 VAC 50 Hz, Full Load. 500 ms, 50 mV /div.

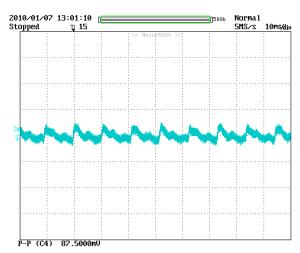
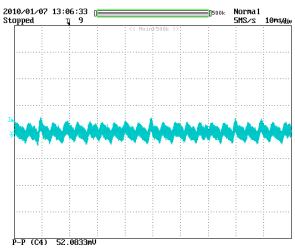
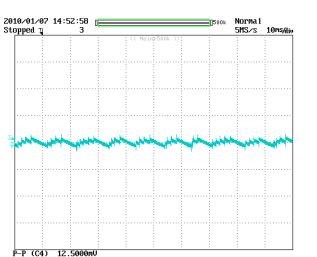


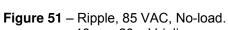
Figure 48 – Ripple, 85 VAC 47 Hz, Full Load. 10 ms, 100 mV / div.

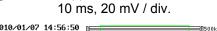


**Figure 50** – Ripple, 264 VAC 50 Hz, Full Load. 10 ms, 50 mV /div.









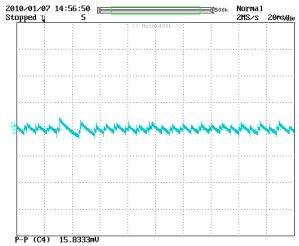


Figure 53– Ripple, 230 VAC, No-load. 10 ms, 20 mV / div.

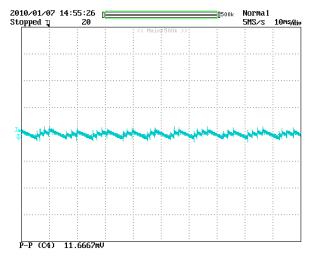


Figure 52 – Ripple, 115 VAC, No-load. 10 ms, 20 mV / div.

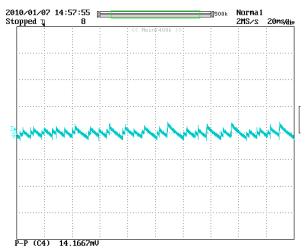
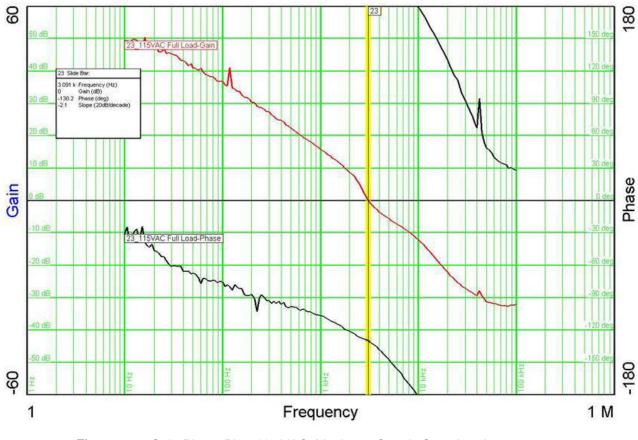


Figure 54 – Ripple, 264 VAC, No-load. 10 ms, 20 mV / div.



# **13 Control Loop Measurements**

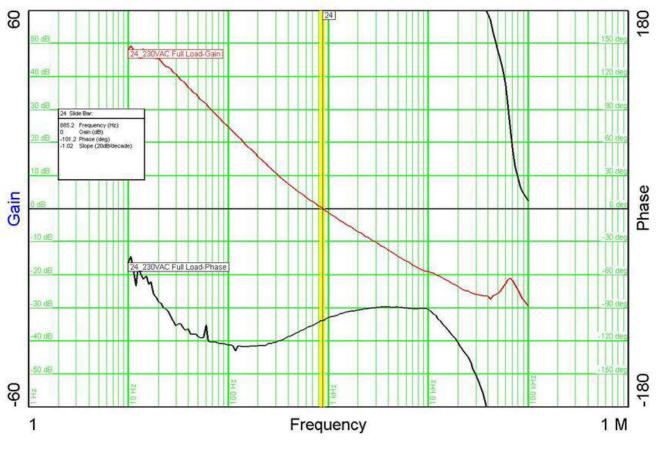
# 13.1 115 VAC Maximum Load



**Figure 55** – Gain-Phase Plot, 115 VAC, Maximum Steady State Load. Crossover Frequency = 3.5 kHz Phase Margin = 51.5°.



# 13.2 230 VAC Maximum Load



**Figure 56** – Gain-Phase Plot, 230 VAC, Maximum Steady State Load. Crossover Frequency = 637.8 Hz, Phase Margin = 71.7°.



# 14 Conducted EMI

Conducted EMI were measured using a resistive load of 4.8  $\Omega$ . Measurements were taken with output grounded and with output floating conditions. Quasi peak and average measurement have both  $\geq$ 10 dB of margin to Class B limits.

# 14.1 Output Grounded

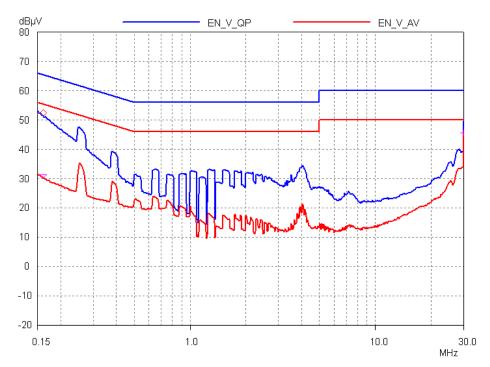


Figure 57 – Phase L1: Conducted EMI, Maximum Steady State Load, 115 VAC, 60 Hz, and EN55022 B Limits. Output Terminal Grounded.



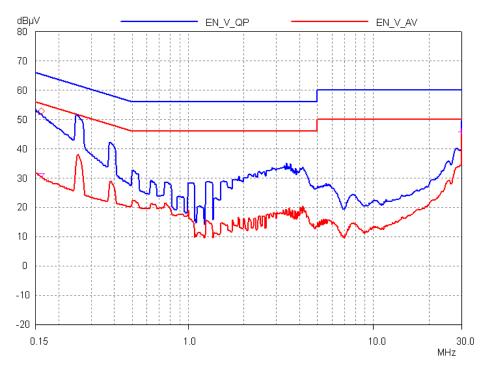


Figure 58 – Phase N: Conducted EMI, Maximum Steady State Load, 115 VAC, 60 Hz, and EN55022 B Limits. Output Terminal Grounded.

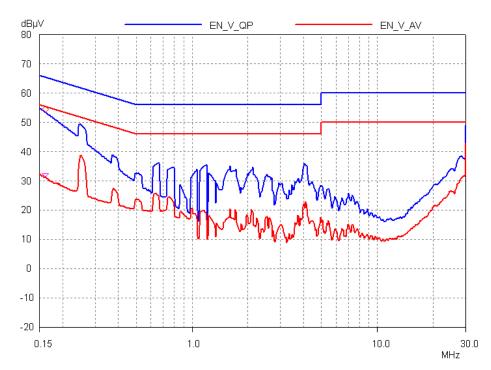


Figure 59 – Phase L1: Conducted EMI, Maximum Steady State Load, 230 VAC, 60 Hz, and EN55022 B Limits. Output Terminal Grounded



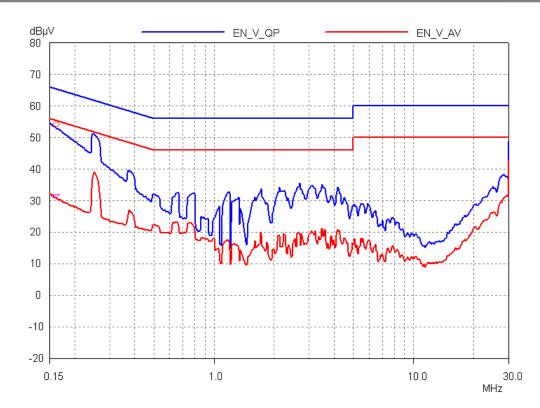


Figure 60 – Phase N: Conducted EMI, Maximum Steady State Load, 230 VAC, 60 Hz, and EN55022 B Limits. Output Terminal Grounded.



# 14.2 Output Floating

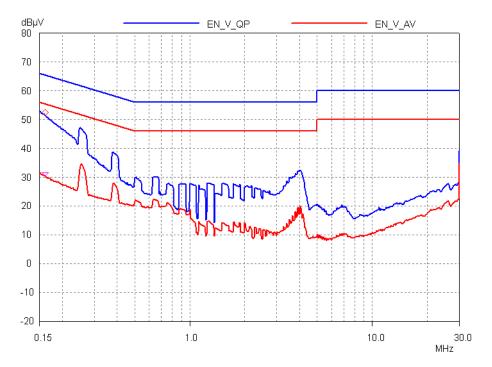


Figure 61 – Phase L1: Conducted EMI, Maximum Steady State Load, 115 VAC, 60 Hz, and EN55022 B Limits. Output Terminal Floating.

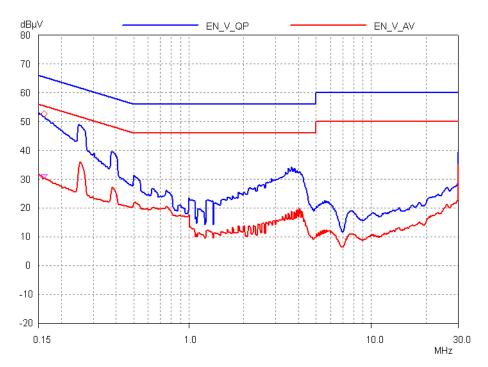


Figure 62 – Phase N: Conducted EMI, Maximum Steady State Load, 115 VAC, 60 Hz, and EN55022 B Limits. Output Terminal Floating.



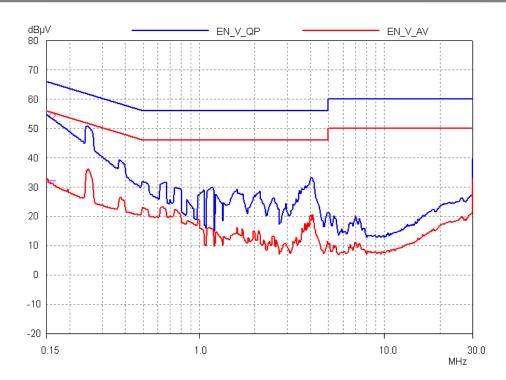


Figure 63 – Phase L1: Conducted EMI, Maximum Steady State Load, 230 VAC, 60 Hz, and EN55022 B Limits. Output Terminal Floating.

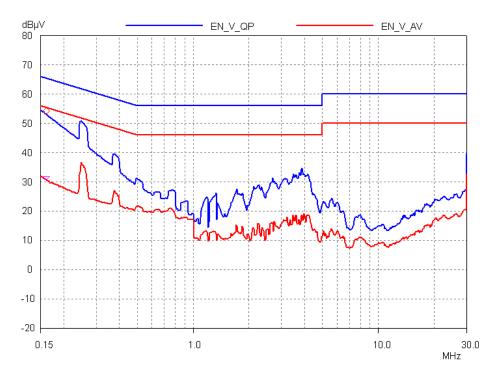


Figure 64 – Phase N: Conducted EMI, Maximum Steady State Load, 230 VAC, 60 Hz, and EN55022 B Limits. Output Terminal Floating.



# 15 AC Surge

The input voltage for the supply under test was 115 VAC and 230 VAC, and the supply was loaded to the maximum continuous output power using resistive loads on each output. An LED was used to monitor the presence of output voltage and to detect output interruptions. A test failure was defined as a non-recoverable interruption of output voltage requiring supply repair or recycling of input AC voltage.

| Surge<br>Voltage<br>(kV) | Phase<br>Angle<br>(°) | Generator<br>Impedance<br>(Ω) | Number of<br>Strikes | Test Result |
|--------------------------|-----------------------|-------------------------------|----------------------|-------------|
| 2                        | 90                    | 12                            | 10                   | PASS        |
| 2                        | 270                   | 12                            | 10                   | PASS        |
| 2.2                      | 90                    | 12                            | 10                   | PASS        |
| 2.2                      | 270                   | 12                            | 10                   | PASS        |
| 2.4                      | 90                    | 12                            | 10                   | PASS        |
| 2.4                      | 270                   | 12                            | 10                   | PASS        |

## 15.1 Common Mode Surge, 1.2 / 50 μsec

### 15.2 Differential Mode Surge, 1.2 / 50 μsec

| Surge<br>Voltage<br>(kV) | Phase<br>Angle<br>(°) | Generator<br>Impedance<br>(Ω) | Number of<br>Strikes | Test Result |
|--------------------------|-----------------------|-------------------------------|----------------------|-------------|
| 1                        | 90                    | 2                             | 10                   | PASS        |
| 1                        | 270                   | 2                             | 10                   | PASS        |
| 1.2                      | 90                    | 2                             | 10                   | PASS        |
| 1.2                      | 270                   | 2                             | 10                   | PASS        |



# 16 Appendix A: Fast AC Reset

The TOPSwitch-JX family has a simplified fast AC Reset Function which can be configured on the X pin. Should a latching OVP condition occur, the circuit below connected to the X pin will force  $I_X$  to exceed  $I_{X(TH)} = -27 \ \mu A$  (typ) and reset the latch when the AC input is disconnected or falls below a set threshold value.

In the circuit below R1, R2 and C1 sets the time after AC is removed before the latch is reset. A higher gain BJT  $Q_R$  is desirable to allow using a higher resistance R1 and lower capacitance C1, and thus minimize the circuit dissipation.

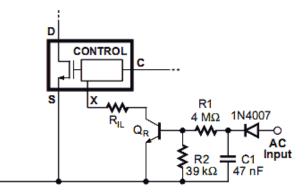


Figure 65 – Fast AC Reset Circuit Implementation for TOPSwitch-JX.



# 17 Appendix B: Circuit Modification for Reduced No-load Input Power and Enhanced Output OVP Performance

The TOPSwitch-JX family is designed to achieve very low no-load input power by reducing the CONTROL pin current  $I_{C(OFF)}$  = 3.5 mA (typical for TOP266VG, 132 kHz) during MCM operation. The value of  $I_{C(OFF)}$  and the bias voltage dictates the power loss in the primary control circuit which contributes to no-load input power losses. This primary circuit loss can be optimized by properly selecting bias voltage to be low enough to minimize the V<sub>BIAS</sub> x I<sub>C(OFF)</sub> product but high enough to maintain supply on the CONTROL pin, typically V<sub>BIAS(VALLEY)</sub> ~7 V. Note that the bias voltage is at minimum during no-load condition at highest AC input/

Another circuit block to look for power savings is the secondary control circuit dissipation during no-load. Power loss associated with the secondary control circuit is related to the output voltage and the control current that flows in the optocoupler diode. The optocoupler diode current is inversely proportional to the CTR of the optocoupler ( $I_{DOPTO} \sim I_{C(OFF)}/CTR$ ), and therefore a higher CTR optocoupler will result in lower secondary side power consumption. In the circuit below, Q2 is added to form a Darlington pair with the optocoupler transistor which now gives a very high equivalent CTR and thus reduces the optocoupler current. This configuration will dramatically improve the no-load power loss savings as shown in the data below. Note that this configuration will result in a higher open loop gain and thus compensation circuit must be redesigned to maintain the necessary stability margins (increasing the value of R19).

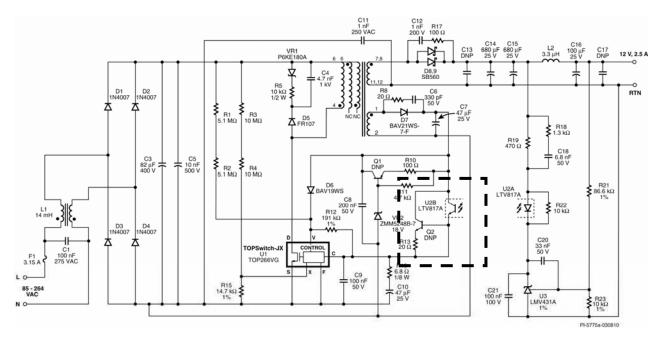


Figure 66 – Optocoupler Darlington Configuration to Reduce Feedback Current and No-load Input Power.



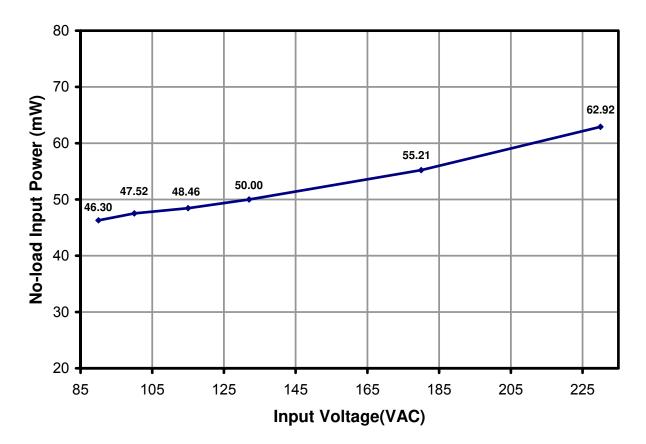


Figure 67 – Zero Load Input Power with Darlington Configuration.

| V <sub>OUT</sub> | Input Line    | P <sub>IN</sub> (mW) |  |
|------------------|---------------|----------------------|--|
| 12               | 85 V / 50 Hz  | 46.30                |  |
| 12               | 100 V / 50 Hz | 47.52                |  |
| 12               | 115 V / 60 Hz | 48.46                |  |
| 12               | 132 V / 60 Hz | 50.00                |  |
| 12               | 180 V / 50 Hz | 55.21                |  |
| 12               | 230 V / 50 Hz | 62.92                |  |
| 12               | 240 V / 50 Hz | 64.28                |  |
| 12               | 264 V / 50 Hz | 67.17                |  |

 Table 4 – No-load Input Power vs. Input Voltage.

# 17.1 Enhanced Output OVP Latch Sensitivity

The network of Q1, R10, R100, C8, and VR2 in Figure 66 guarantees that OVP will latch during low-line over load condition. This circuit will ensure that the required latching current  $I_{OV(LS)}$  = 336  $\mu$ A (typ) is delivered to the V pin for at least 100  $\mu$ s.



# **18 Revision History**

| Date      | Author | Revision | Description & changes | Reviewed    |
|-----------|--------|----------|-----------------------|-------------|
| 01-Mar-10 | CA     | 1.2      | Initial Release       | Apps & Mktg |
|           |        |          |                       |             |
|           |        |          |                       |             |
|           |        |          |                       |             |



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